

REMARKS/ARGUMENTS

Favorable reconsideration of this application in light of the present amendments and following discussion is respectfully requested.

Claims 1-19 are pending. Claims 9-19 have been withdrawn. By this Amendment Claim 1 is amended. Support for the amendments can be found in the specification at least at page 16, line 21- page 17, line 24, page 19, line 15 – page 20, line 20 and figs. 1-6. No new matter has been added.

The Office Action rejects Claims 1-8 under 35 U.S.C. §103(a) over USP 4,792,939 to Hikita et al. in view of U.S. Publication No. 2002/0027009 to Sato et al. This rejection is respectfully traversed.

Neither Hikita et al. nor Sato et al. alone or in combination disclose a first partition provided from a top panel of the shield case to a surface of the mounting substrate and extending from an end of the shield case, a second partition provided from the top panel to the surface of the mounting substrate by extending from another end of the shield case so as to face the first partition across a processor unit and a cut provided from the top panel in the shield case so as to overlay the processor between the first and second partitions as in amended independent Claim 1.

The features of Claim 1 make possible the suppression of direct interference from spurious signals emitted from the transmitting amplifier to the receiving amplifier and electromagnetic disturbance waves leaking from the transmitting unit to the receiving unit.

Hikita et al. discloses a duplex radio communication transceiver including a duplexer 102 connected to an antenna 101, a receiving low noise amplifier 108, a power amplifier 119, and a base band circuit 112 formed on the alumina substrates on the metallic substrate 201. See column 3, line 47 through column 4, line 4, column 4, lines 53-66 and Figs. 1 and 2. The metallic substrates are electromagnetically shielded. See column 8, line 67 through column

9, line 2. However, Hikita et al. does not disclose or suggest a cut provided from the top panel in the shield case so as to overlay the processor unit between the first and second partitions.

Sato et al. does not cure the deficiencies of Hikita et al. Instead, Sato et al. discloses an isolation apparatus for electronic equipment including the cover 24 having a plurality of guide members 52 formed at small intervals away from the first shield case 15. See paragraph [0047] and Fig. 3. The bottom casing 25 has a plurality of support members 51 which support the second upper wall 37 of the second shield case 16 and pressure ribs 54 extending perpendicular to the output shaft 43. See paragraph [0048] and Fig. 3. However, in Sato et al. there is no disclosure or suggestion of a cut provided from the top panel in the shield case so as to overlay the processor unit between the first and second partitions.

For the foregoing reasons it is respectfully submitted that this application is now in condition for allowance. A Notice of Allowance is earnestly solicited.

Should the Examiner deem that any further action is necessary to place this application in even better form for allowance, the Examiner is encouraged to contact the Applicant's undersigned representative at the telephone number listed below.

Respectfully submitted,

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